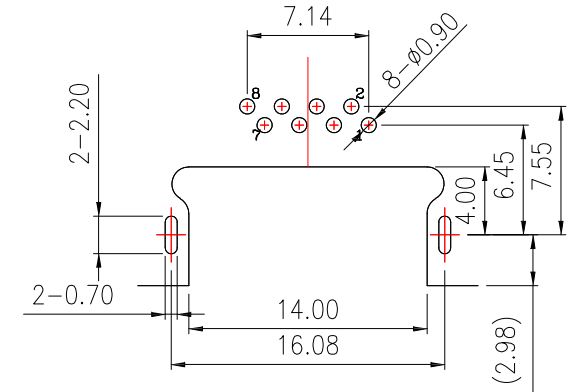
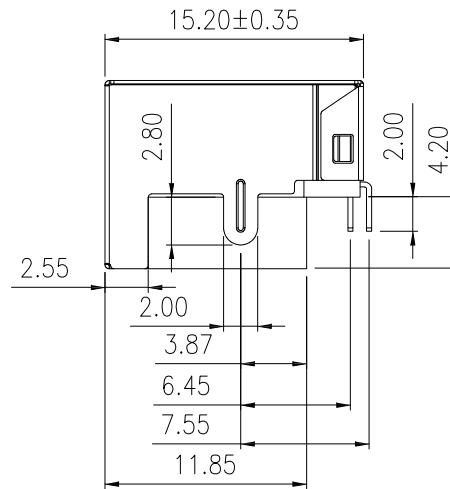
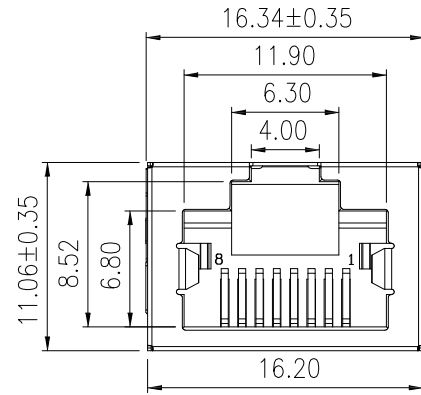
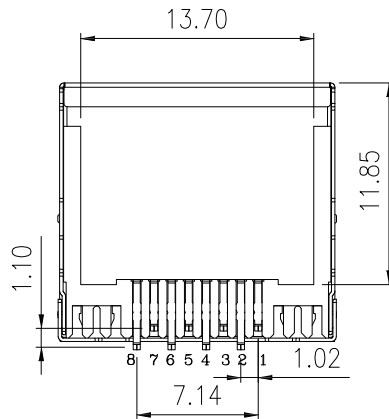




PCB LAYOUT MOUNTING PATTERN



RJ45-58D811E-x-S307

鍍層厚度:

Blank : 1u"
1 : 3u"
2 : 15u"
3 : 30u"
5 : 6u"

SPECIFICATIONS

Electrical:

- 1.Voltage Rating : 125 VAC RMS
- 2.Current Rating : 1.5 A
- 3.Contact Resistance : 30 mΩ MAX
- 4.Insulation Resistance : 1000 MΩ MIN
- 5.Dielectric Strength : 1,000 VAC

Mechanical:

- 1.Housing : LCP
- 2.Contact : Phosphor Bronze , Gold Plating over Nickel
- 3.Shield : Brass , Nickel Plated

Environmental:

- 1.Operation Temperature : -40°C ~ +85°C



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TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE
03/18/21
DATE
03/18/21
DATE
03/18/21

MATL
FINISH
SCALE
SHEET NO.

TITLE
MODLE
DWG NO.
PART NO.

RJ45
RJ45 8P8C 沉板式4.2 mm DIP
RJ45-58D811E-x-S307
RJ45-58D811E-x-S307

SIZE
A4
VER
R3

ITEM NO.	DESCRIPTION	DRAWN	DATE
3	更新圖面	Jack	031821
2	更新尺寸	Jack	010620
1	新增鍍層選項	Jack	112019